

## **MOSFET**

### CoolSiC™ Automotive Power Device 750 V G1

The 750 V CoolSiC™ is built over the solid silicon carbide technology developed in Infineon in more than 20 years. Leveraging the wide bandgap SiC material characteristics, the 750V CoolSiC™ MOSFET offers a unique combination of performance, reliability and ease of use. Suitable for high temperature and harsh operations, it enables the simplified and cost effective deployment of the highest system efficiency.

## **Features**

- Highly robust 750V technology, 100% avalanche tested
- Best-in-class R<sub>DS(on)</sub> x Q<sub>fr</sub>
- Excellent R<sub>DS(on)</sub> x Q<sub>oss</sub> and R<sub>DS(on)</sub> x Q<sub>G</sub>
- Unique combination of low  $C_{rss}/C_{iss}$  and high  $V_{GS(th)}$
- Infineon proprietary die attach technology
- Cutting edge top side cooling package (QDPAK)
- Driver source pin available

### **Benefits**

- Enhanced robustness and reliability for bus voltages beyond 500 V
- Superior efficiency in hard switching
- Higher switching frequency in soft switching topologies
- Robustness against parasitic turn on for unipolar gate driving
- · Best-in-class thermal dissipation
- Reduced switching losses through improved gate control

## Potential applications

Uni- and bidirectional On Board Chargers and HV-LV DCDC converters:

- · hard switching half bridges
- soft switching topologies

### **Product validation**

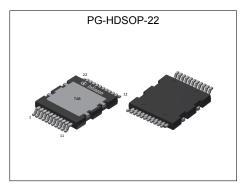
Qualified according to AEC Q101

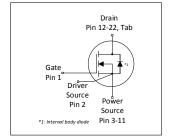
Please note: The source and driver source pins are not exchangeable. Their exchange might lead to malfunction.



Parameter	Value	Unit
$V_{\rm DSS}$ over full $T_{\rm j,range}$	750	V
$R_{\mathrm{DS(on),typ}}$	60	mΩ
R <sub>DS(on),max</sub>	78	mΩ
$Q_{G,typ}$	23	nC
I <sub>DM,max</sub>	89	A
Q <sub>oss,typ</sub> @ 500 V	54	nC
E <sub>oss,typ</sub> @ 500 V	9.6	μJ

Type / Ordering Code	Package	Marking	Related Links
AIMDQ75R060M1H	PG-HDSOP-22	75A060M1	see Appendix A















# **Table of Contents**

escription
aximum ratings 3
ermal characteristics
perating range
ectrical characteristics §
ectrical characteristics diagrams
st Circuits
ckage Outlines
pendix A
evision History
ademarks15
sclaimer 15



1 Maximum ratings at  $T_j = 25$  °C, unless otherwise specified.

Note: for optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Table 2 **Maximum ratings** 

Danamatan	0		Value	s	11	l	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous DC drain current <sup>1)</sup>	I <sub>DDC</sub>	-	-	34 24	А	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	
Peak drain current <sup>2)</sup>	I <sub>DM</sub>	-	-	89	Α	T <sub>C</sub> = 25 °C, V <sub>GS</sub> = 18 V	
Avalanche energy, single pulse	<b>E</b> <sub>AS</sub>	-	-	113	mJ	$I_{\rm D}$ = 4.3 A, $V_{\rm DD}$ = 50 V; see table 11	
Avalanche current, single pulse	I <sub>AS</sub>	-	-	4.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	200	V/ns	V <sub>DS</sub> = 0500 V	
Gate source voltage (static)	V <sub>GS</sub>	-5	-	23	V	-	
Gate source voltage (transient)	V <sub>GS</sub>	-10	-	25	V	$t_p \le 500$ ns, duty cycle $\le 1\%$	
Power dissipation	P <sub>tot</sub>	-	-	167	W	T <sub>C</sub> = 25 °C	
Storage temperature	T <sub>stg</sub>	-55	-	150	°C	-	
Operating junction temperature	T <sub>j</sub>	-55	-	175	°C	-	
Mounting torque	-	-	-	n. a.	Ncm	-	
Continuous reverse drain current <sup>1)</sup>	I <sub>SDC</sub>	-	-	34 21	А	V <sub>GS</sub> = 18 V, T <sub>C</sub> = 25 °C V <sub>GS</sub> = 0 V, T <sub>C</sub> = 25 °C	
Peak reverse drain current <sup>2)</sup>	I <sub>SM</sub>	-	-	89 28	А	$T_{\rm C}$ = 25 °C, $t_{\rm p}$ ≤ 250 ns $T_{\rm C}$ = 25 °C	
Insulation withstand voltage	V <sub>ISO</sub>	-	-	n. a.	V	$V_{\rm rms}, T_{\rm C}$ = 25 °C, $t$ = 1 min	

 $<sup>^{1)}</sup>$  Limited by  $T_{\rm j,max}$  Pulse width  $t_{\rm p}$  limited by  $T_{\rm j,max}$ 



## 2 Thermal characteristics

**Table 3** Thermal characteristics

Parameter	Cymphol	Values			11	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	$R_{th(j-c)}$	-	-	0.9	°C/W	Not subject to production test. Parameter verified by design/characterization according to JESD51-14.
Soldering temperature, reflow soldering allowed	$\mathcal{T}_{sold}$	-	-	260	°C	reflow MSL3

# 3 Operating range

**Table 4** Operating range

Davamatav	Cymbal	Values			Linit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate-source voltage operating range including undershoots <sup>1)</sup>	V <sub>GS</sub>	-2	-	20	V	-
Recommended turn-on voltage	V <sub>GS(on)</sub>	-	18	-	V	-
Recommended turn-off voltage	V <sub>GS(off)</sub>	-	0	-	V	-

<sup>&</sup>lt;sup>1)</sup> **Important notice:** If the gate source voltage of the device in application exceeds the operating range (Table 4), the device  $R_{DS(on)}$  and  $V_{GS(th)}$  might exceed the maximum value stated in the datasheet at the end of the lifetime of the device. In order to ensure sound operation of the device over the planned lifetime, the maximum ratings (Table 2) and the application note AN2018-09 must be considered.



## **Electrical characteristics**

at  $T_i$  = 25 °C, unless otherwise specified

#### Table 5 **Static characteristics**

For applications with applied blocking voltage > 525 V, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical

Parameter	Crombal	Values			1124	Nata / Tarak O am distant
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source voltage <sup>1)</sup>	<b>V</b> <sub>DSS</sub>	750	-	-	V	$V_{GS} = 0 \text{ V}, I_D = 0.40 \text{ mA},$ $T_j = -55 \text{ °C to } 175 \text{ °C}$
Gate threshold voltage <sup>2)</sup>	V <sub>GS(th)</sub>	3.5	4.3	5.6	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 4.0 \text{ mA}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	1 10	75 -	μΑ	$V_{DS} = 750 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ °C}$ $V_{DS} = 750 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 175 \text{ °C}$
Gate-source leakage current	I <sub>GSS</sub>	-	-	100	nA	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	- - - -	74 60 55 108	- 78 - -	mΩ	$V_{\rm GS} = 15 \text{ V}, I_{\rm D} = 11.1 \text{ A}, T_{\rm j} = 25 ^{\circ}\text{C}$ $V_{\rm GS} = 18 \text{ V}, I_{\rm D} = 11.1 \text{ A}, T_{\rm j} = 25 ^{\circ}\text{C}$ $V_{\rm GS} = 20 \text{ V}, I_{\rm D} = 11.1 \text{ A}, T_{\rm j} = 25 ^{\circ}\text{C}$ $V_{\rm GS} = 18 \text{ V}, I_{\rm D} = 11.1 \text{ A}, T_{\rm j} = 175 ^{\circ}\text{C}$
Internal gate resistance	<b>R</b> <sub>G,int</sub>	-	7	-	Ω	f = 1 MHz

#### Table 6 **Dynamic characteristics**

External parasitic elements (PCB layout) influence switching behavior significantly. Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

Parameter	O. mak al	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C <sub>iss</sub>	-	779	-	pF	$V_{GS} = 0 \text{ V}, V_{DS} = 500 \text{ V}, f = 250 \text{ kHz}$
Reverse transfer capacitance	C <sub>rss</sub>	-	4.8	-	pF	$V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 500 V, $f$ = 250 kHz
Output capacitance <sup>3)</sup>	Coss	-	60	78	pF	$V_{GS} = 0 \text{ V}, V_{DS} = 500 \text{ V}, f = 250 \text{ kHz}$
Output charge <sup>3)</sup>	Qoss	-	54	70	nC	calculation based on Coss
Effective output capacitance, energy related <sup>4)</sup>	C <sub>o(er)</sub>	-	77	-	pF	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0500 V
Effective output capacitance, time related <sup>5)</sup>	C <sub>o(tr)</sub>	-	108	-	pF	$I_D$ = constant, $V_{GS}$ = 0 V, $V_{DS}$ = 0500 V
Turn-on delay time	$t_{\sf d(on)}$	-	7	-	ns	$V_{\rm DD}$ = 500 V, $V_{\rm GS}$ = 18 V, $I_{\rm D}$ = 11.1 A, $R_{\rm G}$ = 1.8 $\Omega$ ; see table 10
Rise time	t <sub>r</sub>	-	8	-	ns	$V_{\rm DD} = 500 \text{ V}, V_{\rm GS} = 18 \text{ V}, I_{\rm D} = 11.1 \text{ A}, R_{\rm G} = 1.8 \Omega$ ; see table 10
Turn-off delay time	$t_{\sf d(off)}$	-	14	-	ns	$V_{\rm DD} = 500 \text{ V}, V_{\rm GS} = 18 \text{ V}, I_{\rm D} = 11.1 \text{ A}, R_{\rm G} = 1.8 \Omega$ ; see table 10
Fall time t <sub>f</sub>		-	8	-	ns	$V_{\rm DD}$ = 500 V, $V_{\rm GS}$ = 18 V, $I_{\rm D}$ = 11.1 A $R_{\rm G}$ = 1.8 $\Omega$ ; see table 10

<sup>&</sup>lt;sup>1)</sup> Tested at  $T_j$  = 25 °C, minimum  $V_{DSS}$  verified by design over full junction temperature range. <sup>2)</sup> Tested after 1 ms pulse at  $V_{GS}$  = +20 V. "Linear mode" operation is not recommended. For assessment of potential "linear mode" operation, please contact Infineon sales office.

3) Maximum specification is defined by calculated six sigma upper confidence bound.

 $<sup>^{4)}</sup>$   $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 500 V. <sup>5)</sup>  $C_{o(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 500 V.



 Table 7
 Gate charge characteristics

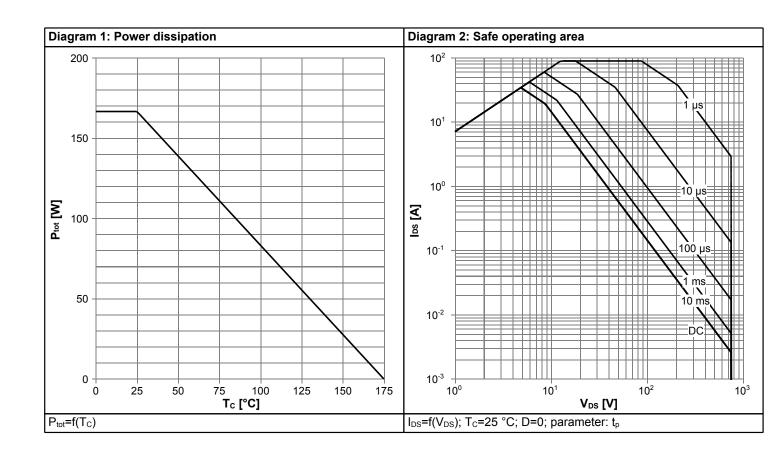
Parameter	Symbol	Values			Unit	Note / Test Condition
raiailietei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Plateau gate to source charge	Q <sub>GS(pl)</sub>	-	6.3	-	nC	$V_{\text{DD}} = 500 \text{ V}, I_{\text{D}} = 11.1 \text{ A}, V_{\text{GS}} = 0 \text{ to } 18 \text{ V}$
Gate to drain charge	$Q_{GD}$	-	5.7	-	nC	$V_{DD}$ = 500 V, $I_{D}$ = 11.1 A, $V_{GS}$ = 0 to 18 V
Total gate charge	Q <sub>G</sub>	-	23	-	nC	$V_{DD} = 500 \text{ V}, I_D = 11.1 \text{ A}, V_{GS} = 0 \text{ to } 18 \text{ V}$

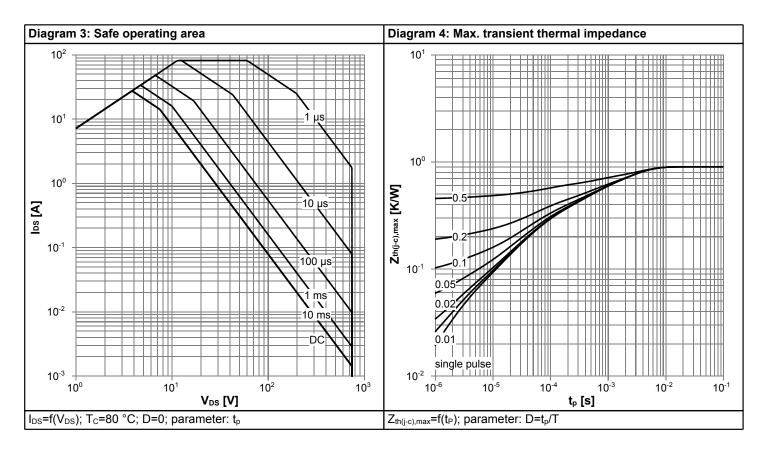
## Table 8 Reverse diode characteristics

Parameter	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source reverse voltage	V <sub>SD</sub>	-	3.9	5.3	V	$V_{\rm GS}$ = 0 V, $I_{\rm S}$ = 11.1 A, $T_{\rm j}$ = 25 °C
MOSFET forward recovery time	$t_{ m fr}$	-	16 10	-	ns	$V_{\rm DD}$ = 500 V, $I_{\rm S}$ = 11.1 A, $di_{\rm S}/dt$ = 1000 A/ $\mu$ s; see table 9 $V_{\rm DD}$ = 500 V, $I_{\rm S}$ = 11.1 A, $di_{\rm S}/dt$ = 4000 A/ $\mu$ s; see table 9
MOSFET forward recovery charge <sup>1)</sup>	Q <sub>fr</sub>	-	57 95	-	nC	$V_{\rm DD}$ = 500 V, $I_{\rm S}$ = 11.1 A, $di_{\rm S}/dt$ = 1000 A/ $\mu$ s; see table 9 $V_{\rm DD}$ = 500 V, $I_{\rm S}$ = 11.1 A, $di_{\rm S}/dt$ = 4000 A/ $\mu$ s; see table 9
MOSFET peak forward recovery current	I <sub>frm</sub>	-	7 20	-	A	$V_{\rm DD}$ = 500 V, $I_{\rm S}$ = 11.1 A, $di_{\rm S}/dt$ = 1000 A/ $\mu$ s; see table 9 $V_{\rm DD}$ = 500 V, $I_{\rm S}$ = 11.1 A, $di_{\rm S}/dt$ = 4000 A/ $\mu$ s; see table 9

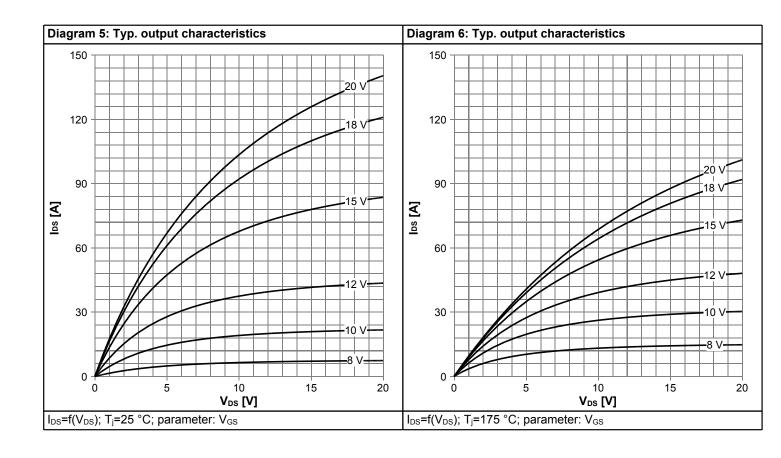


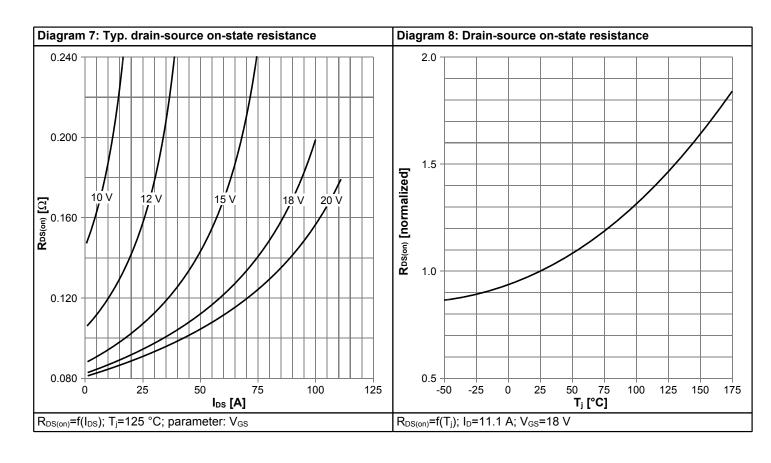
# 5 Electrical characteristics diagrams



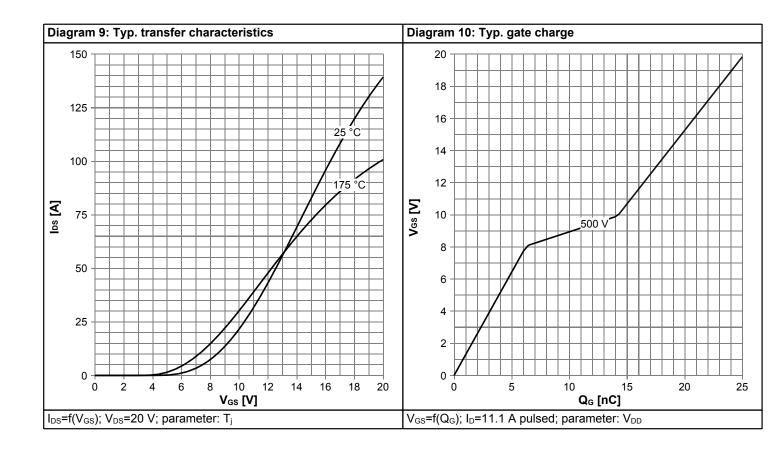


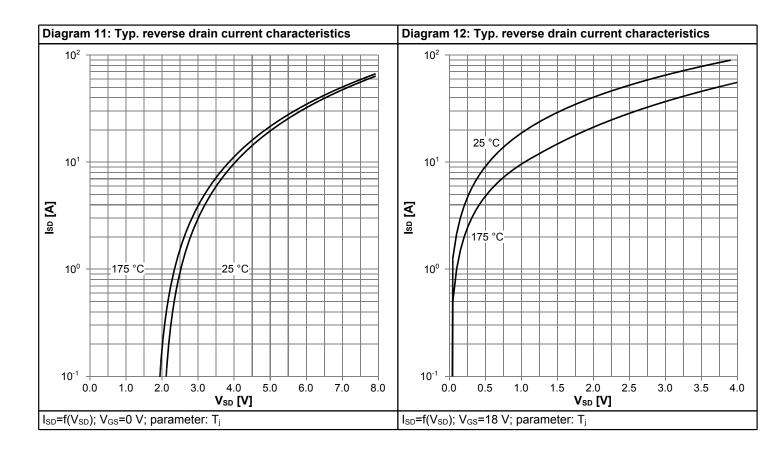




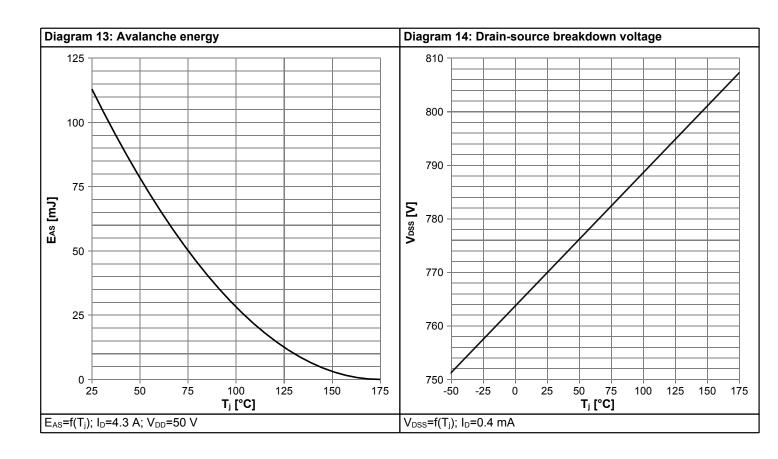


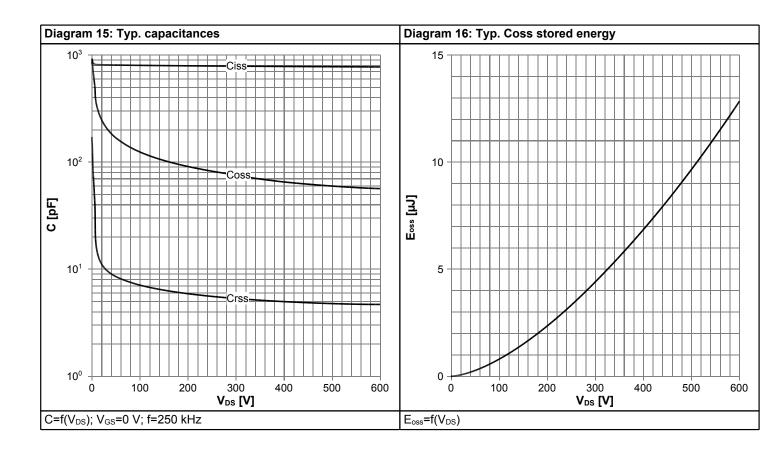




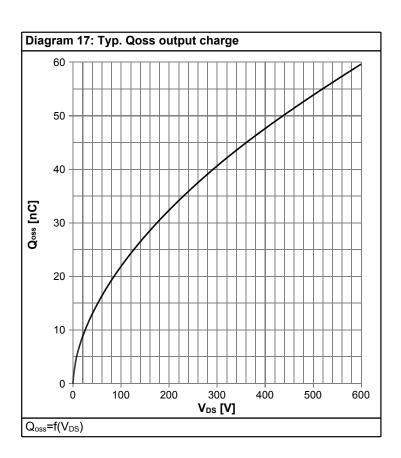














## 6 Test Circuits

Table 9 Body diode characteristics

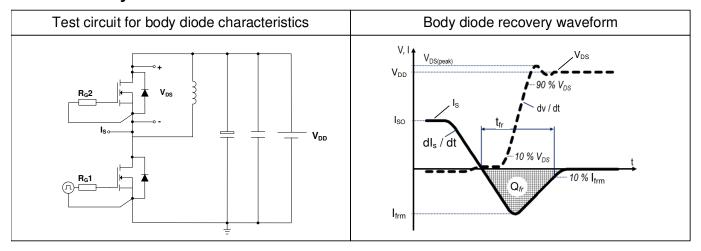


Table 10 Switching times

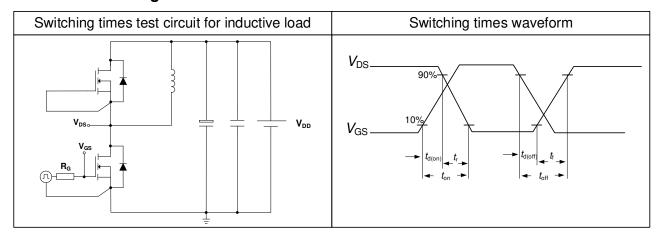
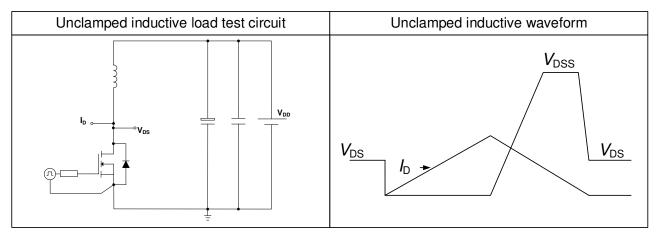


Table 11 Unclamped inductive load





# 7 Package Outlines

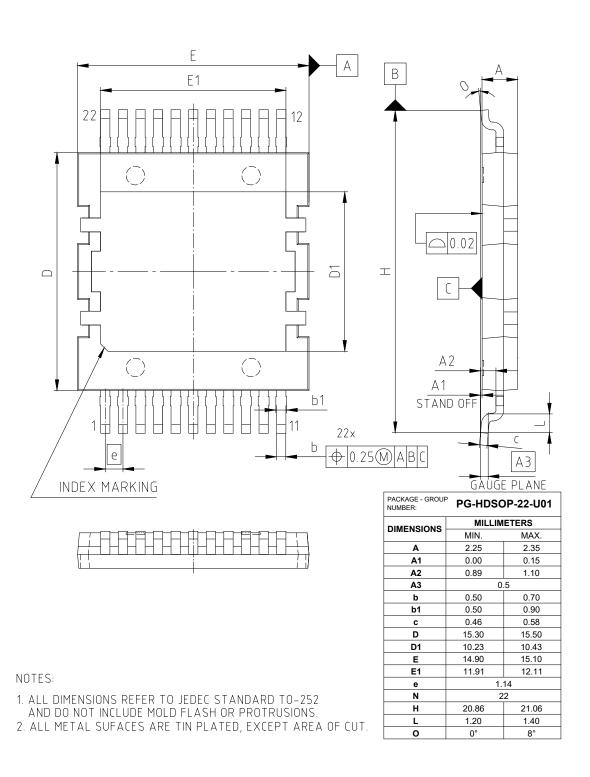


Figure 1 Outline PG-HDSOP-22, dimensions in mm

Final Data Sheet 13 Rev. 2.0, 2024-02-08



# 8 Appendix A

## Table 12 Related Links

- IFX CoolSiC™ Automotive Power Device 750 V G1 Webpage: www.infineon.com
- IFX CoolSiC™ Automotive Power Device 750 V G1 application note: www.infineon.com
- IFX CoolSiC™ Automotive Power Device 750 V G1 simulation model: www.infineon.com
- IFX Design tools: www.infineon.com

# CoolSiC<sup>™</sup> Automotive Power Device 750 V G1



### **Revision History**

AIMDQ75R060M1H

Revision: 2024-02-08, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2024-02-08	Release of final version				

#### Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

### Disclaimer

### We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 München, Germany © 2023 Infineon Technologies AG All Rights Reserved.

#### Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

#### Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

#### Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:

AIMDQ75R060M1HXUMA1